MOSFETs Silicon N-Channel MOS (U-MOSVI-H)

TPCC8061-H

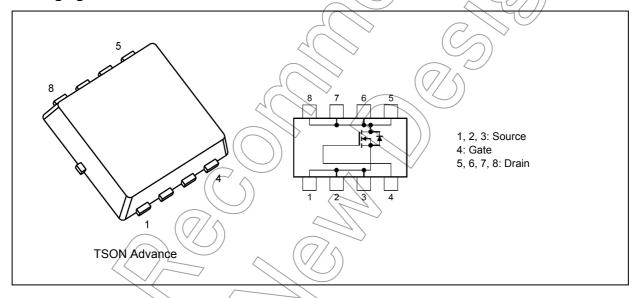
1. Applications

- High-Efficiency DC-DC Converters
- · Notebook PCs
- · Mobile Handsets

2. Features

- (1) Small, thin package
- (2) High-speed switching
- (3) Small gate charge: $Q_{SW} = 3.5 \text{ nC (typ.)}$
- (4) Low drain-source on-resistance: $R_{DS(ON)} = 21 \text{ m}\Omega$ (typ.) $(V_{GS} \neq 4.5 \text{ V})$
- (5) Low leakage current: $I_{DSS} = 10 \mu A \text{ (max) (V}_{DS} = 30 \text{ V)}$
- (6) Enhancement mode: $V_{th} = 1.3 \text{ to } 2.3 \text{ V } (V_{DS} = 10 \text{ V}, I_D = 0.1 \text{ mA})$

3. Packaging and Internal Circuit





4. Absolute Maximum Ratings (Note) (Ta = 25°C unless otherwise specified)

Characteri	Symbol	Rating	Unit		
Drain-source voltage			V _{DSS}	30	V
Gate-source voltage			V _{GSS}	±20	
Drain current (DC)		(Note 1)	I _D	8	Α
Drain current (pulsed)		(Note 1)	I _{DP}	24	
Power dissipation	(T _c = 25°C)		P _D	15	W
Power dissipation	(t = 10 s)	(Note 2)	P _D	1.9	W
Power dissipation	(t = 10 s)	(Note 3)	Pp	0.7	W
Single-pulse avalanche energy		(Note 4)	EAS)) 41	mJ
Avalanche current			I _{AR}	8	Α
Channel temperature			(T _{ch})	150	°C
Storage temperature		6	T _{stg}	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

5. Thermal Characteristics

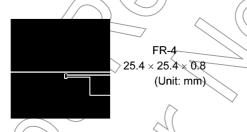
	Characteristics		Symbol	Max	Unit
Channel-to-case thermal resistance	(T _c = 25°C)		R _{th(ch-c)}	8.33	°C/W
Channel-to-ambient thermal resistance	(t = 10 s)	Note 2)	R _{th(ch-a)}	65.7	°C/W
Channel-to-ambient thermal resistance	(t = 10 s)	Note 3)	R _{th(ch-a)}	178	°C/W

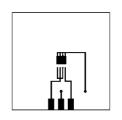
Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: Device mounted on a glass-epoxy board (a), Figure 5.1

Note 3: Device mounted on a glass-epoxy board (b), Figure 5.2

Note 4: $V_{DD} = 24 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 0.5 mH, $R_G = 1.2 \Omega$, $I_{AR} = 8 \text{ A}$





 $\begin{aligned} & \text{FR-4} \\ 25.4 \times 25.4 \times 0.8 \\ & \text{(Unit: mm)} \end{aligned}$

Fig. 5.1 Device Mounted on a Glass-Epoxy Board (a)

Fig. 5.2 Device Mounted on a Glass-Epoxy Board (b)

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

6. Electrical Characteristics

6.1. Static Characteristics (T_a = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I _{GSS}	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±0.1	μΑ
Drain cut-off current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	_	_	10	
Drain-source breakdown voltage	V _{(BR)DSS}	I _D = 10 mA, V _{GS} = 0 V	30			V
	V _{(BR)DSX}	I _D = 10 mA, V _{GS} = -20 V	(15	7		
Gate threshold voltage	V_{th}	V _{DS} = 10 V, I _D = 0.1 mA	1.3	\mathcal{I}_{-}	2.3	
Drain-source on-resistance	R _{DS(ON)}	V _{GS} = 4.5 V, I _D = 4 A	/ A	21	29	mΩ
		V _{GS} = 10 V, I _D = 4 A		18	26	

6.2. Dynamic Characteristics (T_a = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C _{iss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, \Gamma = 1 \text{ MHz}$		630		pF
Reverse transfer capacitance	C _{rss}		-(46	_	
Output capacitance	C _{oss}		7	(150)) —	
Gate resistance	r _g	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 5 \text{ MHz}$		1.4	2.1	Ω
Switching time (rise time)	t _r	See Figure 6.2.1.		2.6	_	ns
Switching time (turn-on time)	t _{on}		/,-]]	7.6		
Switching time (fall time)	t _f		$\widetilde{\ \ }$	2.9	_	
Switching time (turn-off time)	t _{off}) –	18	_	

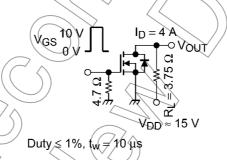


Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics (T_a = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus	$\langle \sqrt{Q_g} \rangle$	$V_{DD} \approx 24 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 8 \text{ A}$	-	11	_	nC
gate-drain)		$V_{DD} \approx 24 \text{ V}, V_{GS} = 5 \text{ V}, I_{D} = 8 \text{ A}$		6.2	_	
Gate-source charge 1	Q _{gs1}	$V_{DD} \approx 24 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 8 \text{ A}$		2.3		
Gate-drain charge	Q_{gd}		_	2.5	_	
Gate switch charge	Q _{SW}		_	3.5	_	

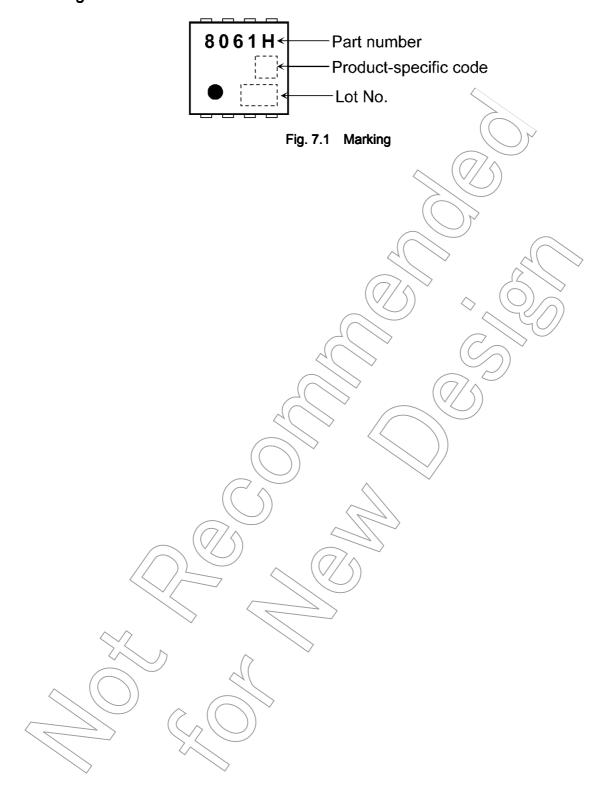
6.4. Source-Drain Characteristics (T_a = 25°C unless otherwise specified)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (pulsed)	(Note 5)	I _{DRP}	_	_	_	24	Α
Diode forward voltage		V_{DSF}	I _{DR} = 8 A, V _{GS} = 0 V	1		-1.2	V

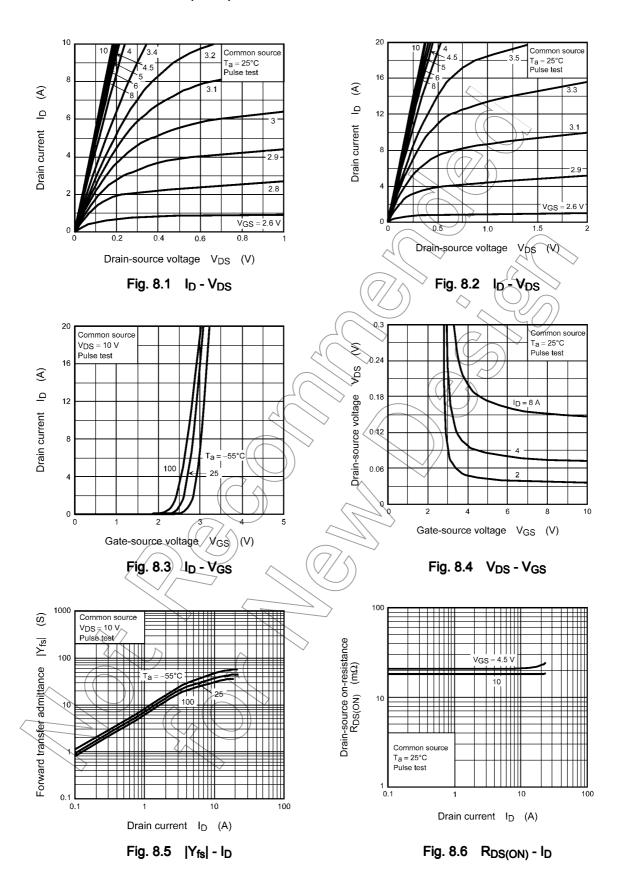
Note 5: Ensure that the channel temperature does not exceed 150°C.



7. Marking



8. Characteristics Curves (Note)



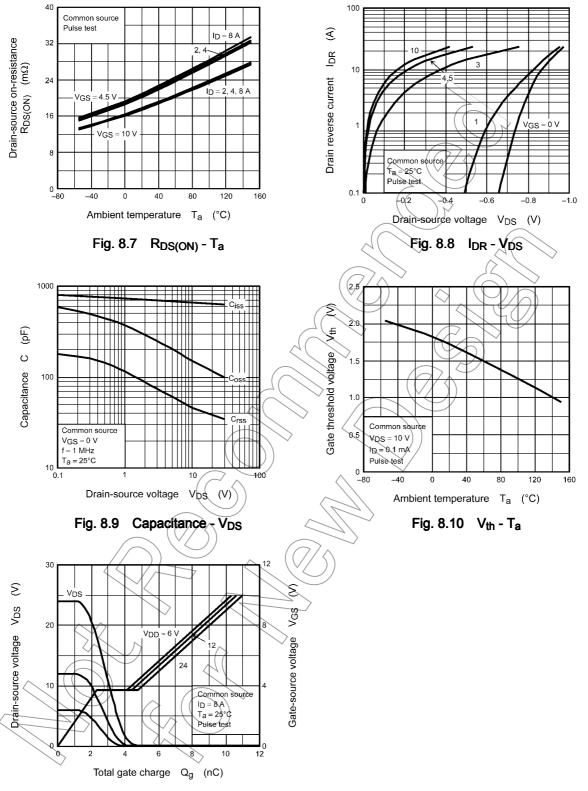


Fig. 8.11 Dynamic Input/Output Characteristics

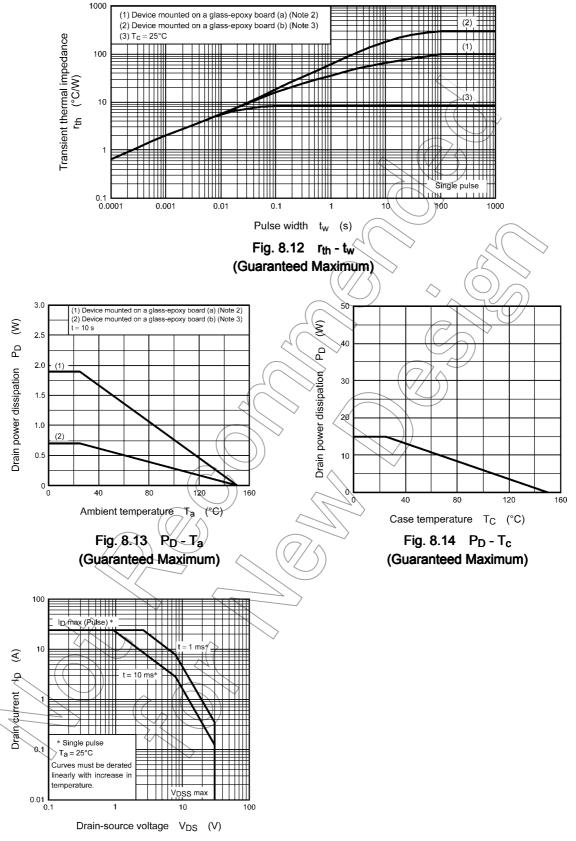


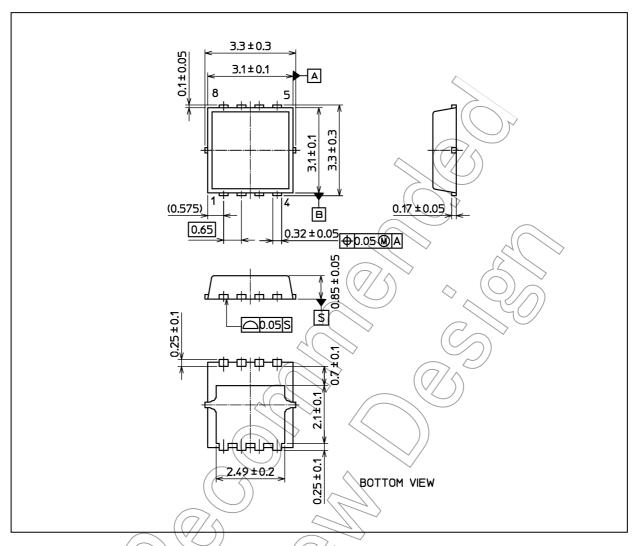
Fig. 8.15 Safe Operating Area (Guaranteed Maximum)

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

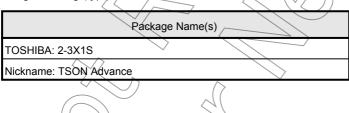


Package Dimensions

Unit: mm



Weight: 0.02 g (typ.)





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